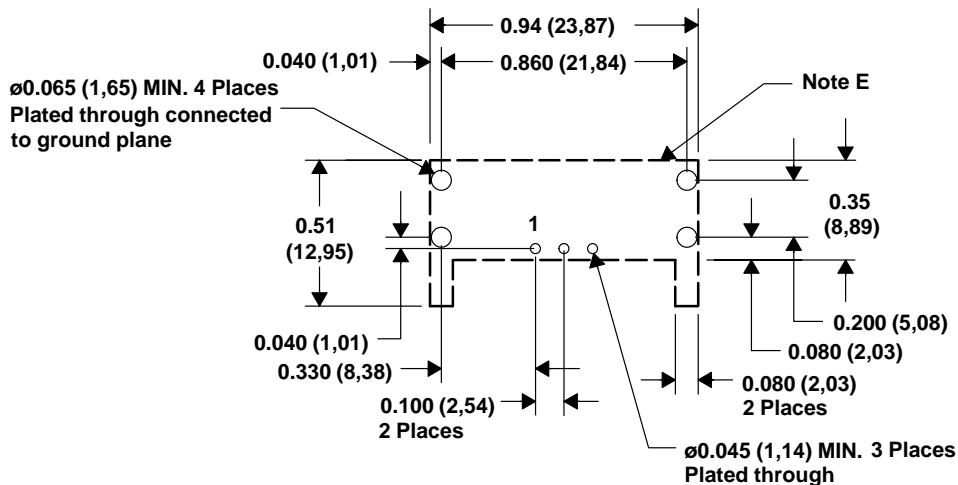
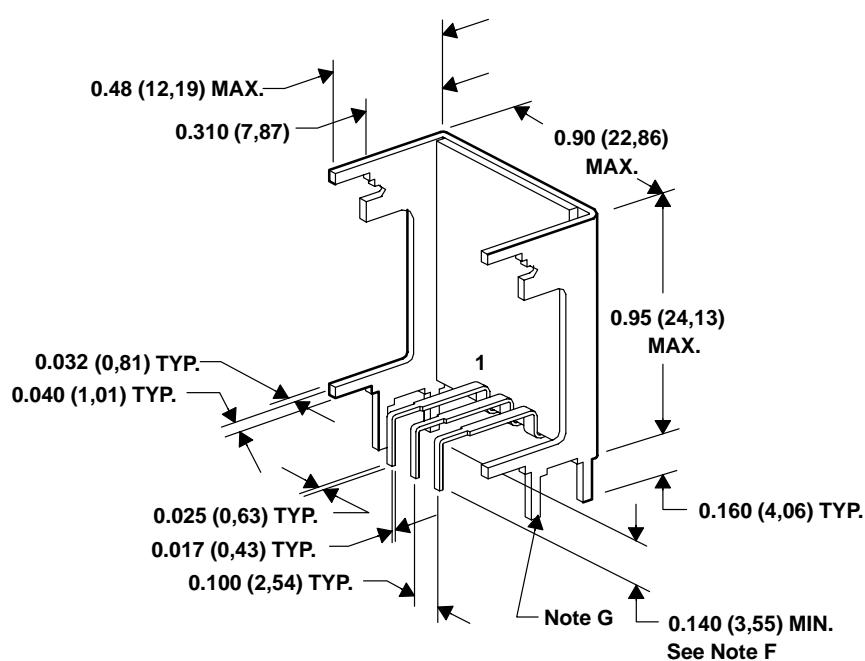


EFN (R-MSIP-T3)

METAL SINGLE-IN-LINE MODULE

Suffix N



PC LAYOUT (TOP VIEW)

4204576/A 07/02

NOTES:

- A. All linear dimensions are in inches (mm).
- B. This drawing is subject to change without notice.
- C. 2 place decimals are ± 0.030 (± 0.76 mm).
- D. 3 place decimals are ± 0.010 (± 0.25 mm).
- E. Recommended mechanical keep out area.
- F. Electrical pin length mounted on circuit board seating plane to pin end.
- G. Electrically connect case to ground plane.

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